

# New Jersey Semi-Conductor Products, Inc.

20 STERN AVE.  
SPRINGFIELD, NEW JERSEY 07081  
U.S.A.

**IRFZ34**

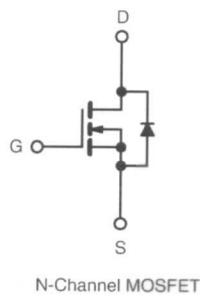
TELEPHONE: (973) 376-2922  
(212) 227-6005  
FAX: (973) 376-8960

## Power MOSFET

PRODUCT SUMMARY	
$V_{DS}$ (V)	60
$R_{DS(on)}$ ( $\Omega$ )	$V_{GS} = 10$ V      0.050
$Q_g$ (Max.) (nC)	46
$Q_{gs}$ (nC)	11
$Q_{gd}$ (nC)	22
Configuration	Single

### FEATURES

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Ease of Parallelizing
- Simple Drive Requirements



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current	$I_D$	30	A
		21	
Pulsed Drain Current <sup>a</sup>	$I_{DM}$	120	
Linear Derating Factor		0.59	W/°C
Single Pulse Avalanche Energy <sup>b</sup>	$E_{AS}$	200	mJ
Maximum Power Dissipation	$P_D$	88	W
Peak Diode Recovery dV/dt <sup>c</sup>	dV/dt	4.5	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to + 175	°C
Soldering Recommendations (Peak Temperature)	for 10 s	300 <sup>d</sup>	
Mounting Torque	6-32 or M3 screw	10	lbf · in
		1.1	N · m

### Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD} = 25$  V, starting  $T_J = 25$  °C,  $L = 259$   $\mu$ H,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 30$  A (see fig. 12).
- $I_{SD} \leq 30$  A,  $dI/dt \leq 200$  A/ $\mu$ s,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C.
- 1.6 mm from case.

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### THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	62	$^{\circ}\text{C}/\text{W}$
Case-to-Sink, Flat, Greased Surface	$R_{thCS}$	0.50	-	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	1.7	

### SPECIFICATIONS ( $T_J = 25^{\circ}\text{C}$ , unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
<b>Static</b>								
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$		60	-	-	V	
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25^{\circ}\text{C}$ , $I_D = 1 \text{ mA}$		-	0.065	-	$\text{V}/^{\circ}\text{C}$	
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$		2.0	-	4.0	V	
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20 \text{ V}$		-	-	$\pm 100$	nA	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 60 \text{ V}$ , $V_{GS} = 0 \text{ V}$		-	-	25	$\mu\text{A}$	
		$V_{DS} = 48 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 150^{\circ}\text{C}$		-	-	250		
Drain-Source On-State Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}$	$I_D = 18 \text{ A}^b$	-	-	0.050	$\Omega$	
Forward Transconductance	$g_{fs}$	$V_{DS} = 25 \text{ V}$ , $I_D = 18 \text{ A}$		9.3	-	-	S	
<b>Dynamic</b>								
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1.0 \text{ MHz}$ , see fig. 5		-	1200	-	pF	
Output Capacitance	$C_{oss}$			-	600	-		
Reverse Transfer Capacitance	$C_{rss}$			-	100	-		
Total Gate Charge	$Q_g$	$V_{GS} = 10 \text{ V}$	$I_D = 30 \text{ A}$ , $V_{DS} = 48 \text{ V}$ , see fig. 6 and 13 <sup>b</sup>	-	-	46	nC	
Gate-Source Charge	$Q_{gs}$			-	-	11		
Gate-Drain Charge	$Q_{gd}$			-	-	22		
Turn-On Delay Time	$t_{d(\text{on})}$			-	13	-		
Rise Time	$t_r$	$V_{DD} = 30 \text{ V}$ , $I_D = 30 \text{ A}$ , $R_g = 12 \Omega$ , $R_D = 1.0 \Omega$ , see fig. 10 <sup>b</sup>		-	100	-	ns	
Turn-Off Delay Time	$t_{d(\text{off})}$			-	29	-		
Fall Time	$t_f$			-	52	-		
Internal Drain Inductance	$L_D$			-	4.5	-	nH	
Internal Source Inductance	$L_S$	Between lead, 6 mm (0.25") from package and center of die contact		-	7.5	-		
<b>Drain-Source Body Diode Characteristics</b>								
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode		-	-	30	A	
Pulsed Diode Forward Current <sup>a</sup>	$I_{SM}$			-	-	120		
Body Diode Voltage	$V_{SD}$	$T_J = 25^{\circ}\text{C}$ , $I_S = 30 \text{ A}$ , $V_{GS} = 0 \text{ V}^b$		-	-	1.6	V	
Body Diode Reverse Recovery Time	$t_{rr}$	$T_J = 25^{\circ}\text{C}$ , $I_F = 30 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$		-	120	230	ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$			-	0.7	1.4	nC	
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )						

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).  
b. Pulse width  $\leq 300 \mu\text{s}$ ; duty cycle  $\leq 2\%$ .